

10/579198

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Correspondence Customer Number:: 02101

Application Information

Title Line One:: A Method for Manufacturing a Solid Plating
Title Line Two:: Material and the Solid Plating Material
Title Line Three:: Manufactured by the Method
Total Drawing Sheets::
Formal Drawings?::
Application Type:: Utility
Docket Number:: 2471A/114

Representative Information

Registration Number:: 33,198

This application is a:: 371 of
> Application One:: PCT/JP2004/015684
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Prior Applications

Application One:: 2003-382435
Filing Date:: 12 November 2003
Country:: Japan
Priority Claimed:: Yes